

Title: Liaison response to ODVA
From: IEEE 802.1
For: Information
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To: ODVA
Katherine Voss, President, ODVA, kvoss@odva.org
Steve Zuponic, ODVA Board of Directors, sazuponic@ra.rockwell.com
Jordon Woods, Analog Devices, Inc., acting IEEE-ODVA Liaison, jordon.woods@analog.com

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Dear Ms. Voss, dear colleagues,

We thank ODVA and Jordon Woods for the presentation of your recent liaison. We have reviewed your request for information and are providing the following draft specifications:

- IEEE P802.1Qcc
- IEEE P802.1CB
- IEEE P802.1AS-Rev
- IEEE P802.1Qcp
- IEEE P802.1Qcn

We would welcome presentations on ODVA and use cases. We would also welcome draft ODVA specifications, e.g., ones referring to IEEE 802.1 specifications. We hope that we can continue to cooperate, both by liaison messages and by common participation in the two organizations.

Respectfully submitted,

Glenn Parsons
Chair, IEEE 802.1 WG
CC: John Messenger, Vice-chair, IEEE 802.1 WG;
János Farkas, Chair, IEEE 802.1 TSN TG